

## N-Channel Trench Power MOSFET

### General Description

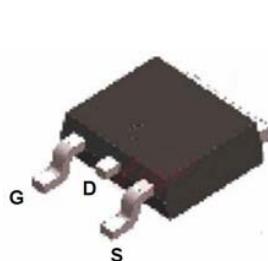
The PTI EPJÖ is N-channel MOS Field Effect Transistor designed for high current switching applications. Rugged EAS capability and ultra low  $R_{DS(ON)}$  is suitable for PWM, load switching especially for E-Bike controller applications.

### Features

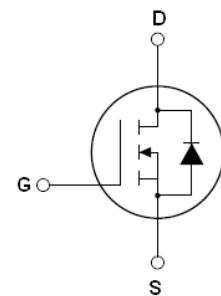
- $V_{DS}=70V$ ;  $I_D=90A$  @  $V_{GS}=10V$ ;  
 $R_{DS(ON)}<5.2m\Omega$  @  $V_{GS}=10V$
- Special Designed for E-Bike Controller Application
- Ultra Low On-Resistance
- High UIS and UIS 100% Test

### Application

- 48V E-Bike Controller Applications
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



TO-263-2L top view



Schematic diagram

$V_{DSS} = 70V$

$I_{DSS} = 90A$

$R_{DS(ON)} = 4.8m\Omega$

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
PTI EPJÖ	PTI EPJÖ	TO-263-2L	1000	25mm	1

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	70	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 25$	V
$I_D$ (DC)	Drain Current (DC) at $T_c=25^\circ C$	90	A
$I_D$ (DC)	Drain Current (DC) at $T_c=100^\circ C$	63	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	320	A
$dv/dt$	Peak Diode Recovery Voltage	30	V/ns
$P_D$	Maximum Power Dissipation( $T_c=25^\circ C$ )	145	W
	Derating Factor	1.9	W/ $^\circ C$
$E_{AS}$	Single Pulse Avalanche Energy (Note 2)	590	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	$^\circ C$

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition: $T_J=25^\circ C$ ,  $V_{DD}=33V$ ,  $V_G=10V$ ,  $I_D=48.5A$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	0.6	°C/W

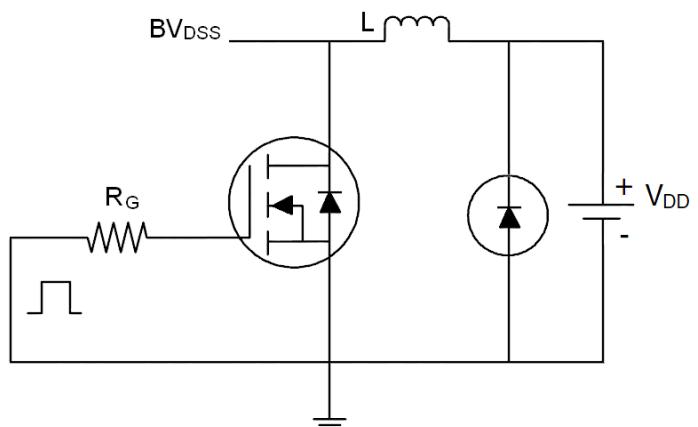
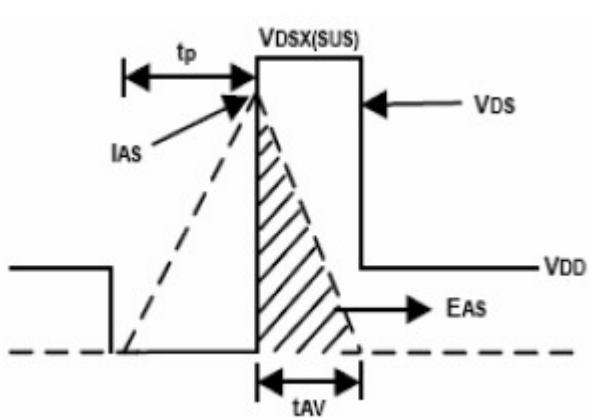
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$		70		V
$I_{DS(on)}$	Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )	$V_{DS}=68V, V_{GS}=0V$			1	$\mu A$
$I_{DS(on)}$	Zero Gate Voltage Drain Current( $T_c=125^\circ C$ )	$V_{DS}=68V, V_{GS}=0V$			1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$		4.8	5.2	$m\Omega$
<b>Dynamic Characteristics</b>						
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=40A$		28		S
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		4858		pF
$C_{oss}$	Output Capacitance			883		pF
$C_{rss}$	Reverse Transfer Capacitance			486		pF
$Q_g$	Total Gate Charge	$V_{DS}=30V, I_D=30A, V_{GS}=10V$		81		nC
$Q_{gs}$	Gate-Source Charge			15		nC
$Q_{gd}$	Gate-Drain Charge			22		nC
<b>Switching Times</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=30V, I_D=2A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$		13		nS
$t_r$	Turn-on Rise Time			15		nS
$t_{d(off)}$	Turn-Off Delay Time			27		nS
$t_f$	Turn-Off Fall Time			32		nS
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current(Body Diode)			80		A
$I_{SDM}$	Pulsed Source-Drain Current(Body Diode)			320		A
$V_{SD}$	Forward On Voltage <b>(Note 1)</b>	$T_J=25^\circ C, I_{SD}=40A, V_{GS}=0V$		0.8	0.95	V
$t_{rr}$	Reverse Recovery Time <b>(Note 1)</b>	$T_J=25^\circ C, I_F=75A, di/dt=100A/\mu s$		49		nS
$Q_{rr}$	Reverse Recovery Charge <b>(Note 1)</b>			97		nC
$t_{on}$	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ )				

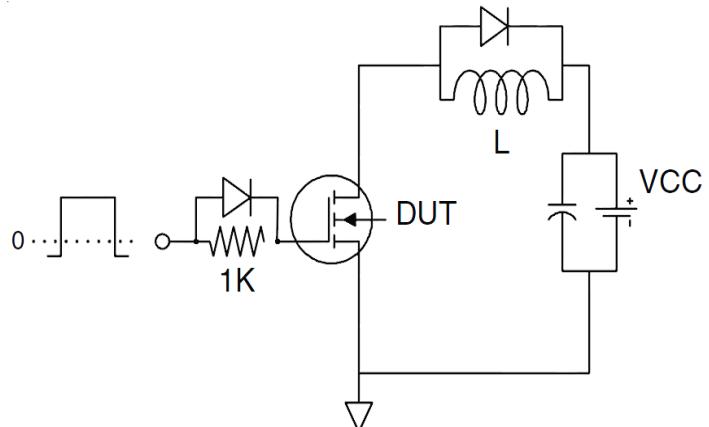
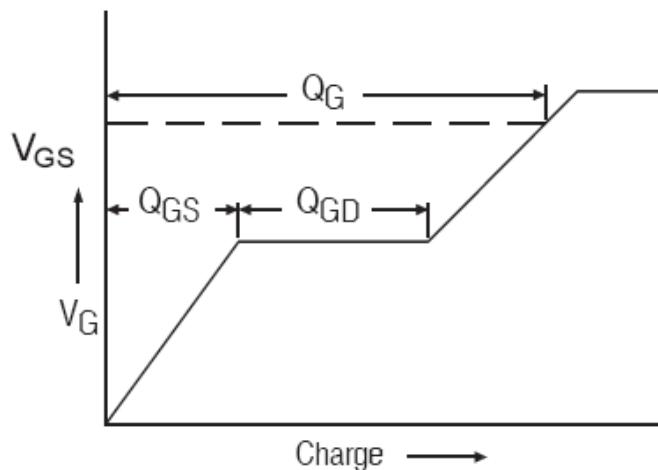
Notes 1.Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 1.5\%$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ C$

## Test Circuit

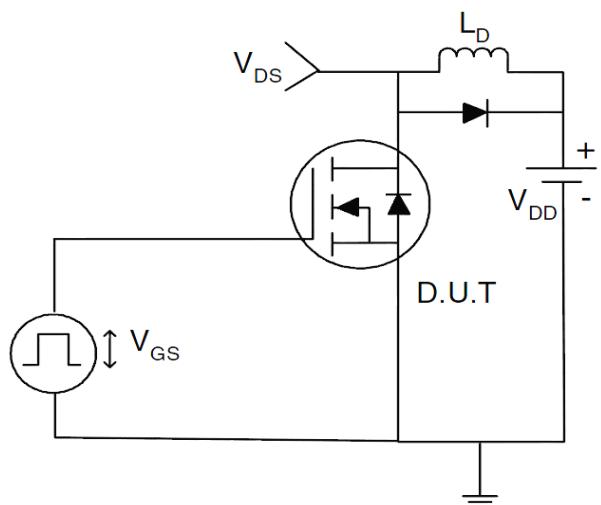
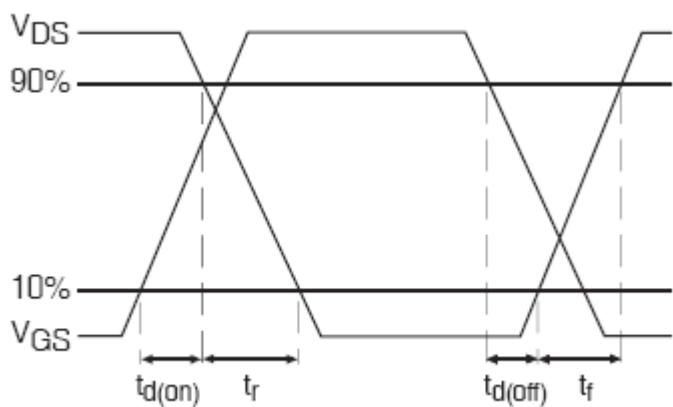
### 1) EAS Test Circuits



### 2) Gate Charge Test Circuit:

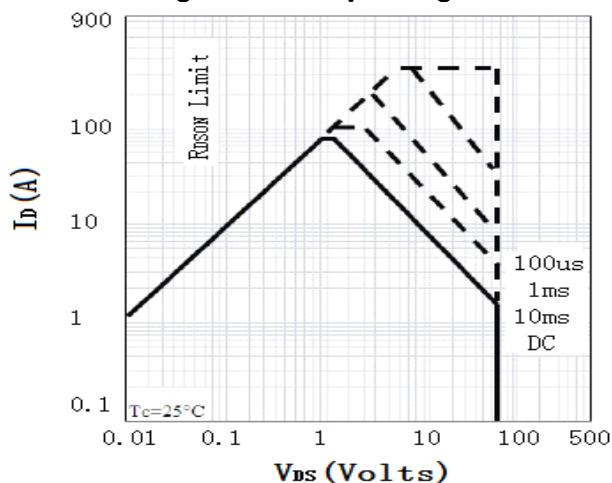


### 3) Switch Time Test Circuit:

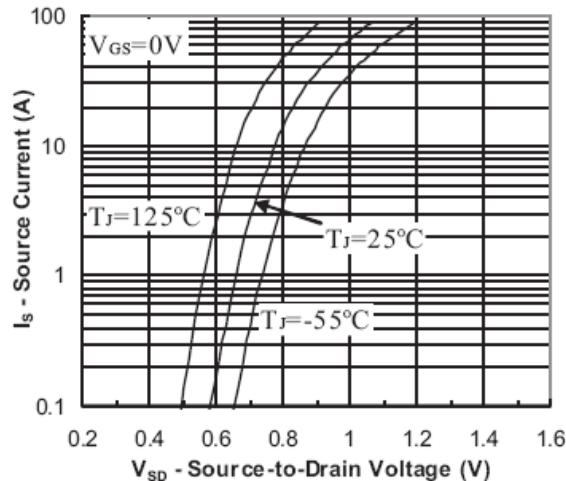


## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

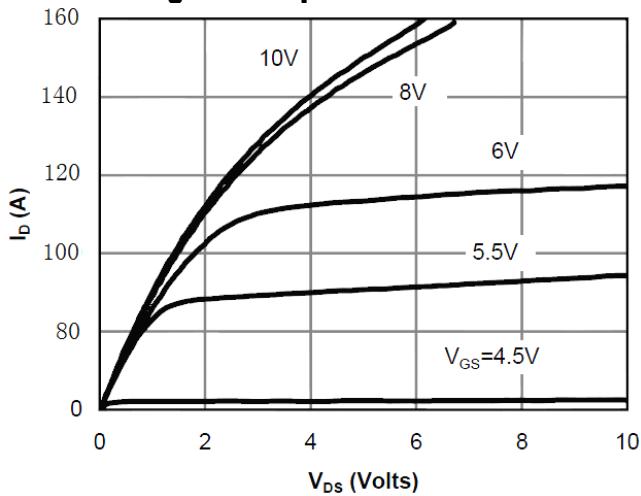
**Figure1. Safe Operating Area**



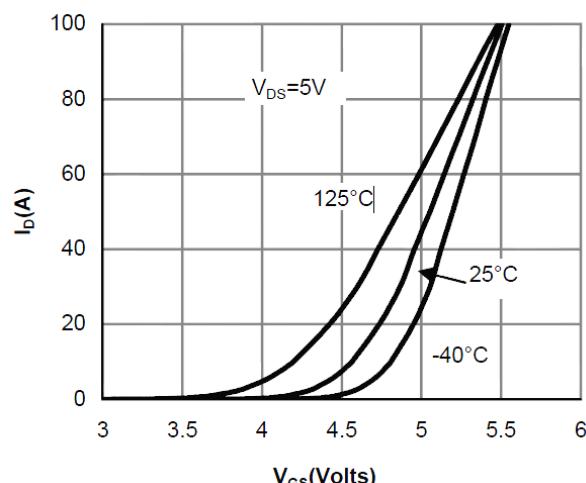
**Figure2. Source-Drain Diode Forward Voltage**



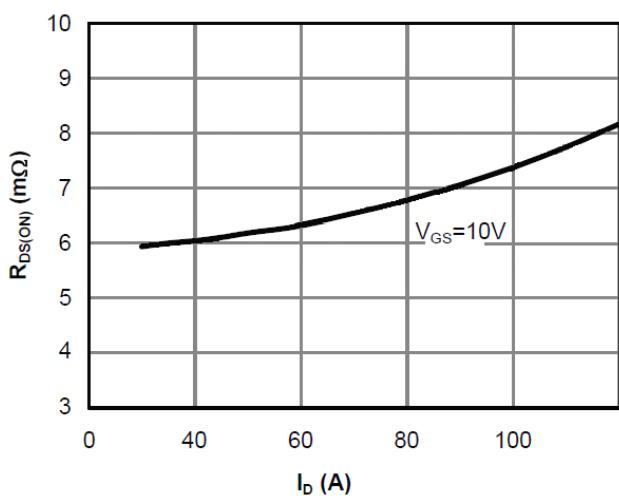
**Figure3. Output Characteristics**



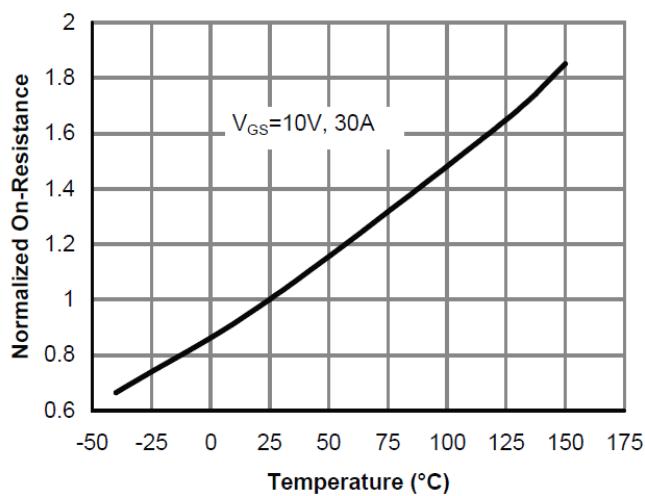
**Figure4. Transfer Characteristics**



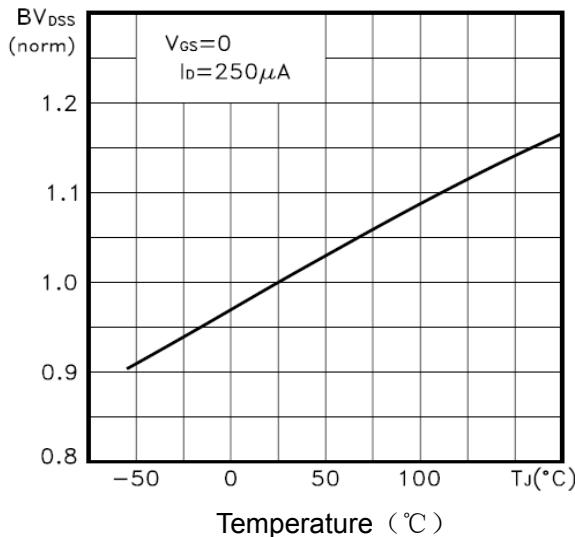
**Figure5. Static Drain-Source On Resistance**



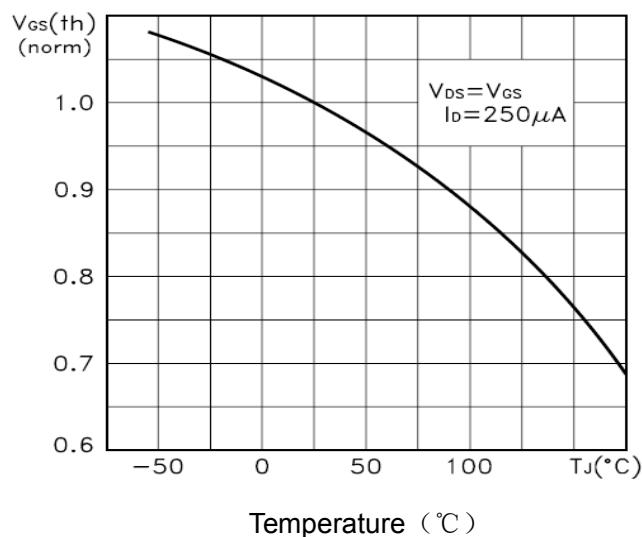
**Figure6.  $R_{DS(ON)}$  vs Junction Temperature**



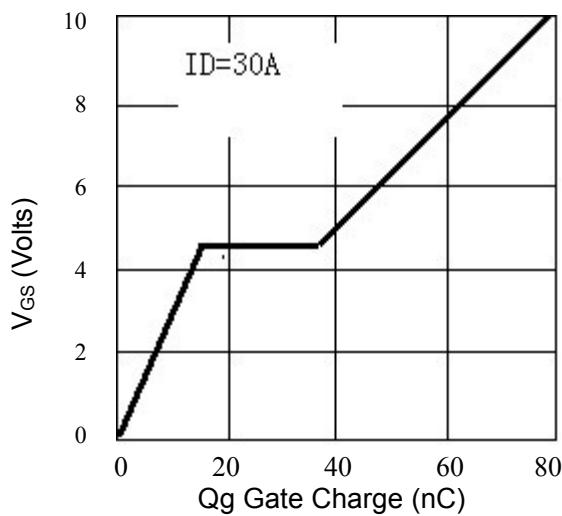
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



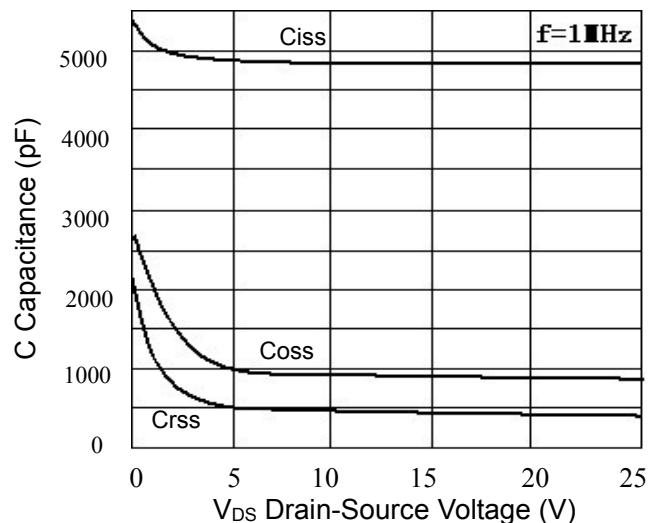
**Figure8.  $V_{GS(th)}$  vs Junction Temperature**



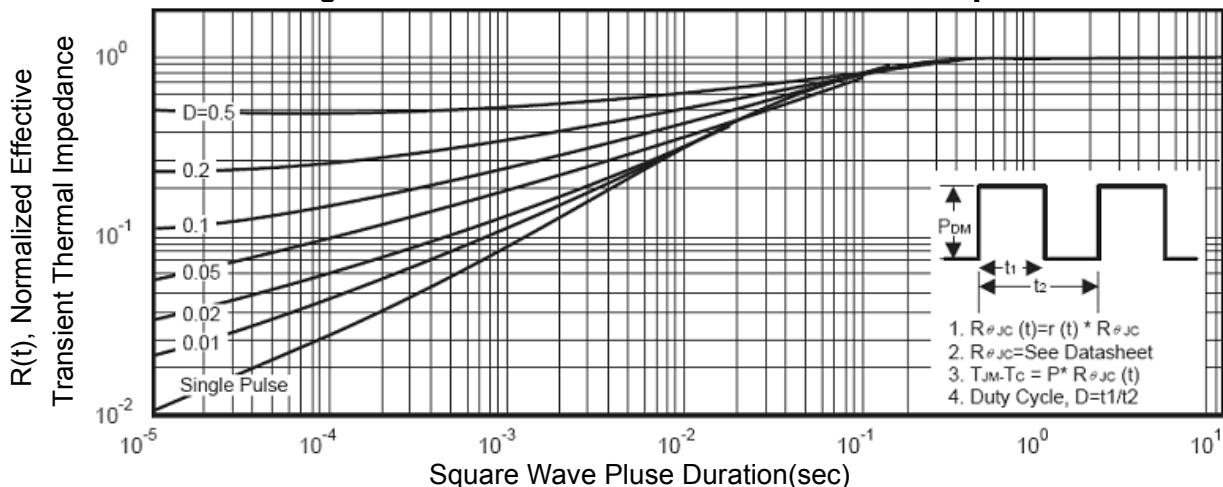
**Figure9. Gate Charge Waveforms**



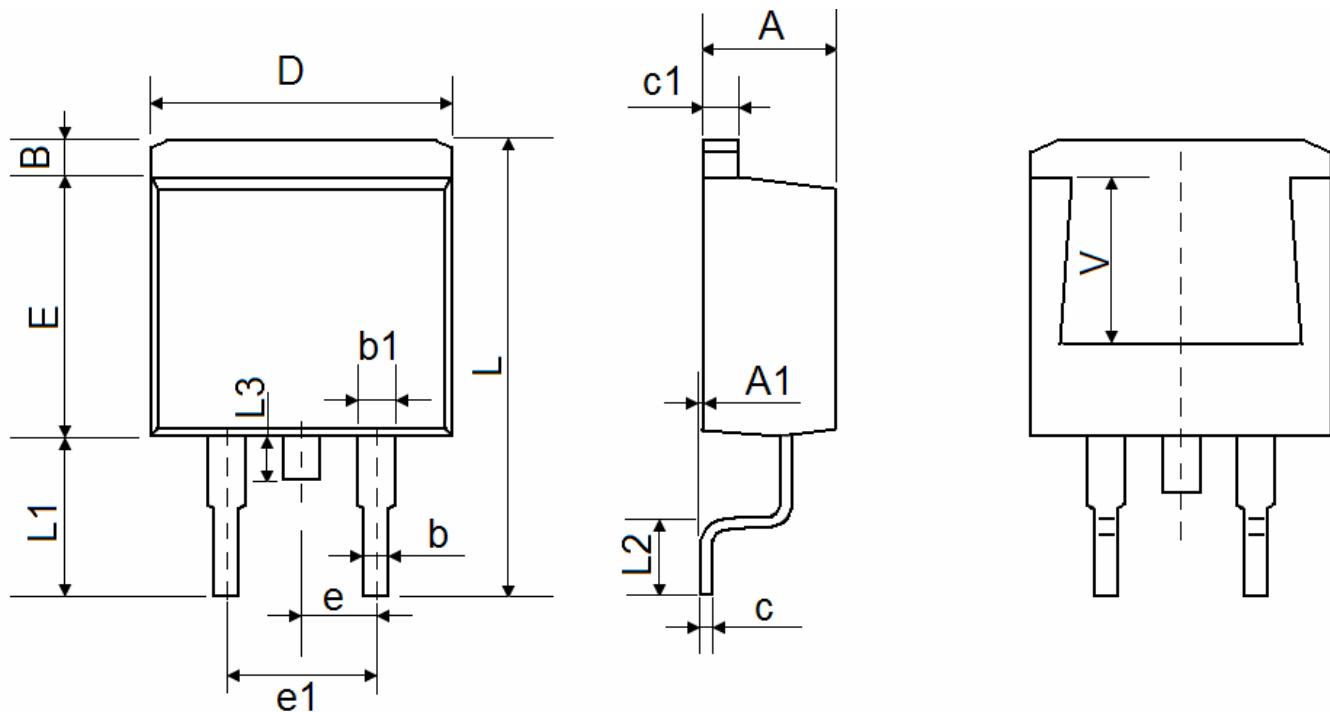
**Figure10. Capacitance**



**Figure11. Normalized Maximum Transient Thermal Impedance**



## TO-263-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.170	1.370	0.046	0.054
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	15.050	15.450	0.593	0.608
L1	5.080	5.480	0.200	0.216
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF		0.220 REF	